

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Michael Bauer et al.
Filed: Herewith
Docket: I431.103.101/FIN 423 US
Title: ELECTRONIC COMPONENT AND SEMICONDUCTOR WAFER, AND
METHOD FOR PRODUCING THE SAME

INFORMATION DISCLOSURE STATEMENT

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Dear Sir:

In compliance with the duty of disclosure under 37 C.F.R. § 1.56, it is respectfully requested that this Information Disclosure Statement be entered and the documents listed on attached form 1449 be considered by the Examiner and made of record. Any required copies of patents, publications or other documents are enclosed for the Examiner's review. Pursuant to the provisions of M.P.E.P. 609, Applicants further request a copy of the 1449 form, marked as being considered and initialled by the Examiner, be returned with the next Official Communication.

Since this Information Disclosure Statement is being submitted within three months of filing national application; or date of entry of national application; or before the mailing date of the first Office Action on the merits, a fee has not been enclosed. However, if such fee is required, the Patent Office is hereby authorized to charge Deposit Account No. 500471 for fees as set forth under 37 C.F.R. 1.17(p).

Information Disclosure Statement

Applicant: Michael Bauer et al.

Filing Date: Herewith

Docket: FIN 423 US/I431.103.101

Title: ELECTRONIC COMPONENT AND SEMICONDUCTOR WAFER, AND METHOD FOR PRODUCING THE SAME

Applicants respectfully request consideration of these references during prosecution of the above-identified matter. The Examiner is invited to contact the Applicants' representative at the below-listed telephone number if there are any questions regarding this Communication or the tendered references.

Respectfully submitted,

Michael Bauer et al.,

By their attorneys,

DICKE, BILLIG & CZAJA, PLLC

Fifth Street Towers, Suite 2250

100 South Fifth Street

Minneapolis, MN 55402

Telephone: (612) 767-2502

Facsimile: (612) 573-2005

Dated: 4/27/04

PPK:cmj


Paul P. Kempf

Reg. No. 39,727

CERTIFICATE UNDER 37 C.F.R. 1.10:

"Express Mail" mailing label number: EV409552130US

Date of Deposit: February 27, 2004

The undersigned hereby certifies that this paper or papers, as described herein, are being deposited in the United States Postal Service "Express Mail Post Office to Addressee" service under 37 C.F.R. 1.10 on the date indicated above and is addressed to: Mail Stop Patent Application, Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450.

By 
Name: Vernell Beal

| | | |
|---|--------------------------------------|-------------|
| FORM PTO-1449 | Docket No.: I431.103.101/FIN423US | Serial No.: |
| LIST OF PATENTS AND PUBLICATIONS FOR APPLICANT'S INFORMATION DISCLOSURE STATEMENT | Applicant: Michael Bauer et al. | |
| | | |
| | Filing Date: Herewith | Group Art: |

U.S. PATENT DOCUMENTS

| Examiner Initial | Document No. | Date | Name | Class | Sub Class | Filing Date If Appropriate |
|---------------------|----------------|---------|-----------------|-------|-----------|-------------------------------|
| AA | 5,126,286 | 6/1992 | Chance | | | |
| AB | US2002/0094607 | 7/2002 | Gerbauer et al. | | | |
| AC | US2002/0158345 | 10/2002 | Hedler et al. | | | |
| AD | | | | | | |
| AE | | | | | | |
| AF | | | | | | |
| AG | | | | | | |
| AH | | | | | | |
| AI | | | | | | |
| AJ | | | | | | |
| AK | | | | | | |
| AL | | | | | | |

FOREIGN PATENT DOCUMENTS

| | Document No. | Date | Country | Class | Sub Class | Translated Yes No |
|----|--------------|------|---------|-------|-----------|----------------------|
| AM | | | | | | Yes |
| AN | | | | | | Yes |
| AO | | | | | | Yes |

OTHER ART (Including Author, Title, Date, Pertinent Pages, Etc.)

| | |
|----|--|
| AP | |
| AQ | |
| AR | |

EXAMINER:

DATE CONSIDERED:

EXAMINER: Initial if citation considered, whether or not citation is in conformance with MPEP 609; draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.